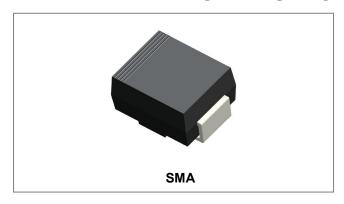


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SL21A SCHOTTKY RECTIFIER



Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Power Loss, High Efficiency
- High Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Terminals finish: 100% Pure Tin
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- · Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Disk drives
- Battery charging

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	10	V	
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @T _L =110°C, rectangular wave form	2	Α	
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3ms, Half Sine pulse, T _c = 25 °C	50	Α	

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	@ 2A, Pulse, T _J = 25 °C	-	0.35	V
	V _{F2}	@ 2A, Pulse, T _J = 100 °C	-	0.26	V
Reverse Current*	I _{R1}	@V _R = rated V _R , T _J = 25 °C		0.7	mA
	I _{R2}	@V _R = rated V _R , T _J = 100 °C	-	60	mA
Series Inductance	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

^{*} Pulse width < 300 µs, duty cycle < 2%



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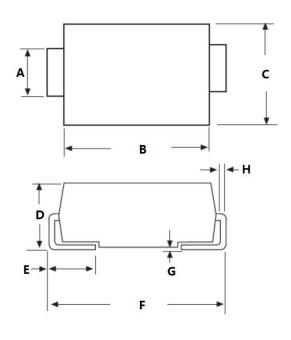




Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	T_J	-	-55 to +125	°C
Storage Temperature	T_{stg}	-	-55 to +125	°C
Maximum Thermal Resistance Junction to Lead	$R_{ heta JL}$	-	15	°C/W
Maximum Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	-	81	°C/W
Approximate Weight	wt	-	0.06	g

Mechanical Dimensions SMA



SYMBOL	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
А	1.25	1.65	0.049	0.065	
В	3.95	4.60	0.156	0.181	
С	2.25	2.95	0.089	0.116	
D	1.95	2.90	0.077	0.114	
E	0.75	1.60	0.030	0.063	
F	4.80	5.60	0.189	0.220	
G	0.05	0.20	0.002	0.008	
Н	0.15	0.41	0.006	0.016	

Ordering Information

Device	Package	Shipping
SL21A	SMA (Pb-Free)	5000pcs / reel
SL21ATR	SMA (Pb-Free)	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

 SL
 = Device Type

 2
 = Forward Current (2A)

 1
 = Reverse Voltage (10V)

 A
 = Package type

 YY
 = Year

 WW
 = Week

Cautions: Molding resin

Epoxy resin UL:94V-0

= Lot Number

- China Germany Korea Singapore United States •
- http://www.smc-diodes.com sales@ smc-diodes.com •

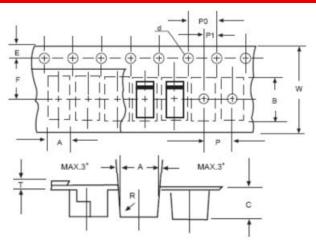


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Carrier Tape Specification SMA



SYMBOL	Millimeters		
	Min.	Max.	
Α	2.97	3.17	
В	5.70	5.90	
С	2.32	2.52	
d	1.40	1.60	
E	1.40	1.60	
F	5.60	5.70	
Р	3.90	4.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	0.25	0.35	
W	11.80	12.20	

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